



CHENMKO ENTERPRISE CO.,LTD

Lead free devices

**SURFACE MOUNT
Complementary Small Signal Transistor**

VOLTAGE 40 Volts CURRENT 0.2 Ampere

CHT3946UPNPT

APPLICATION

- * Telephony and professional communication equipment.
- * Other switching applications.

FEATURE

- * Small surface mounting type. (SC-88/SOT363)
- * Low current (Max.=200mA).
- * Suitable for high packing density.
- * Low voltage (Max.=40V).
- * High saturation current capability.
- * Voltage controlled small signal switch.

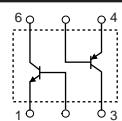
CONSTRUCTION

- * Complementary Pair
- * One CH3904-Type NPN
- One CH3906-Type PNP

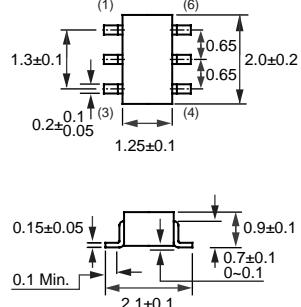
MARKING

- * U4

CIRCUIT



SC-88/SOT-363



Dimensions in millimeters

SC-88/SOT-363

CH3904 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	—	60	V
V_{CEO}	collector-emitter voltage	open base	—	40	V
V_{EBO}	emitter-base voltage	open collector	—	6	V
I_C	collector current DC		—	200	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	—	200	mW
T_{stg}	storage temperature		-65	+150	°C

CH3906 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	—	-40	V
V_{CEO}	collector-emitter voltage	open base	—	-40	V
V_{EBO}	emitter-base voltage	open collector	—	-5	V
I_C	collector current DC		—	-200	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	—	200	mW
T_{stg}	storage temperature		-65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

RATING CHARACTERISTIC CURVES (CHT3946UPNPT)

CH3904 THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	500	K/W

Note

- Transistor mounted on an FR4 printed-circuit board.

CH3904 CHARACTERISTICS

$T_{amb} = 25^\circ C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0; V_{CB} = 30 V$	—	50	nA
I_{EBO}	emitter cut-off current	$I_C = 0; V_{EB} = 6 V$	—	50	nA
h_{FE}	DC current gain	$V_{CE} = 1 V$; note 1 $I_C = 0.1 mA$ $I_C = 1 mA$ $I_C = 10 mA$ $I_C = 50 mA$ $I_C = 100 mA$	40 70 100 60 30	— — 300 — —	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 10 mA; I_B = 1 mA$	—	200	mV
		$I_C = 50 mA; I_B = 5 mA$	—	300	mV
V_{BEsat}	base-emitter saturation voltage	$I_C = 10 mA; I_B = 1 mA$	650	850	mV
		$I_C = 50 mA; I_B = 5 mA$	—	950	mV
C_c	collector capacitance	$I_E = i_e = 0; V_{CB} = 5 V; f = 1 MHz$	—	4	pF
C_e	emitter capacitance	$I_C = i_c = 0; V_{BE} = 500 mV; f = 1 MHz$	—	8	pF
f_T	transition frequency	$I_C = 10 mA; V_{CE} = 20 V; f = 100 MHz$	300	—	MHz
F	noise figure	$I_C = 100 \mu A; V_{CE} = 5 V; R_S = 1 k\Omega; f = 10 Hz to 15.7 kHz$	—	5	dB

Switching times (between 10% and 90% levels);

t_{on}	turn-on time	$I_{Con} = 10 mA; I_{Bon} = 1 mA; I_{Boff} = -1 mA$	—	65	ns
t_d	delay time		—	35	ns
t_r	rise time		—	35	ns
t_{off}	turn-off time		—	240	ns
t_s	storage time		—	200	ns
t_f	fall time		—	50	ns

Note

- Pulse test: $t_p \leq 300 \mu s; \delta \leq 0.02$.

RATING CHARACTERISTIC CURVES (CHT3946UPNPT)

CH3906 THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	500	K/W

Note

- Transistor mounted on an FR4 printed-circuit board.

CH3906 CHARACTERISTICS

$T_{amb} = 25^\circ C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0; V_{CB} = -30 V$	—	-50	nA
I_{EBO}	emitter cut-off current	$I_C = 0; V_{EB} = 6 V$	—	-50	nA
h_{FE}	DC current gain	$V_{CE} = -1 V$; note 1 $I_C = -0.1 mA$ $I_C = -1 mA$ $I_C = -10 mA$ $I_C = -50 mA$ $I_C = -100 mA$	60 80 100 60 30	— — 300 — —	
V_{CEsat}	collector-emitter saturation voltage	$I_C = -10 mA; I_B = -1 mA$ $I_C = -50 mA; I_B = -5 mA$	— —	-250 -400	mV
V_{BEsat}	base-emitter saturation voltage	$I_C = -10 mA; I_B = -1 mA$ $I_C = -50 mA; I_B = -5 mA$	-650 —	-850 -950	mV
C_c	collector capacitance	$I_E = i_e = 0; V_{CB} = -5 V; f = 1 MHz$	—	4.5	pF
C_e	emitter capacitance	$I_C = i_e = 0; V_{EB} = -500 mV; f = 1 MHz$	—	10	pF
f_T	transition frequency	$I_C = 10 mA; V_{CE} = -20 V; f = 100 MHz$	250	—	MHz
F	noise figure	$I_C = 100 \mu A; V_{CE} = -5 V; R_S = 1 k\Omega; f = 10 Hz to 15.7 kHz$	—	4	dB

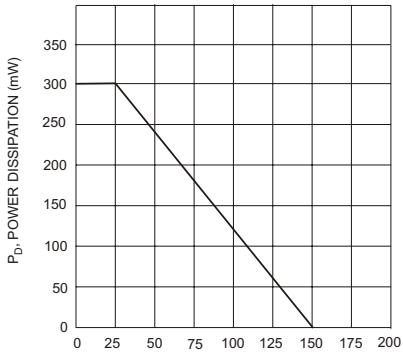
Switching times (between 10% and 90% levels);

t_{on}	turn-on time	$I_{Con} = -10 mA; I_{Bon} = -1 mA; I_{Boff} = 1 mA$	—	65	ns
t_d	delay time		—	35	ns
t_r	rise time		—	35	ns
t_{off}	turn-off time		—	300	ns
t_s	storage time		—	225	ns
t_f	fall time		—	75	ns

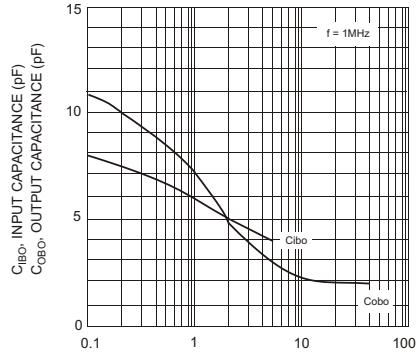
Note

- Pulse test: $t_p \leq 300 \mu s; \delta \leq 0.02$.

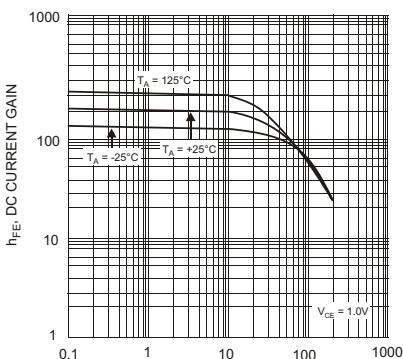
RATING CHARACTERISTIC CURVES (CHT3946UPNPT)



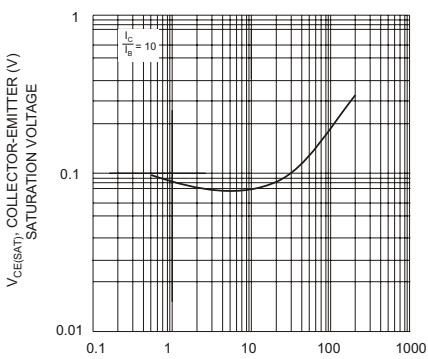
T_A , AMBIENT TEMPERATURE (°C)
Fig. 1, Max Power Dissipation vs.
Ambient Temperature (Total Device)



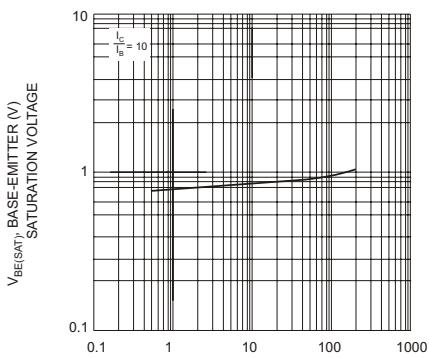
V_{CB} , COLLECTOR-BASE VOLTAGE (V)
Fig. 2, Input and Output Capacitance vs.
Collector-Base Voltage (NPN-CH3904)



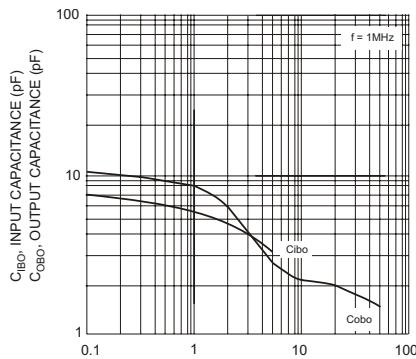
I_C , COLLECTOR CURRENT (mA)
Fig. 3, Typical DC Current Gain vs.
Collector Current (NPN-CH3904)



I_C , COLLECTOR CURRENT (mA)
Fig. 4, Typical Collector-Emitter
Saturation Voltage vs. Collector Current (NPN-CH3904)



I_C , COLLECTOR CURRENT (mA)
Fig. 5, Typical Base-Emitter
Saturation Voltage vs. Collector Current (NPN-CH3904)



V_{CB} , COLLECTOR-BASE VOLTAGE (V)
Fig. 6, Input and Output Capacitance vs.
Collector-Base Voltage (NPN-CH3904)

RATING CHARACTERISTIC CURVES (CHT3946UPNPT)

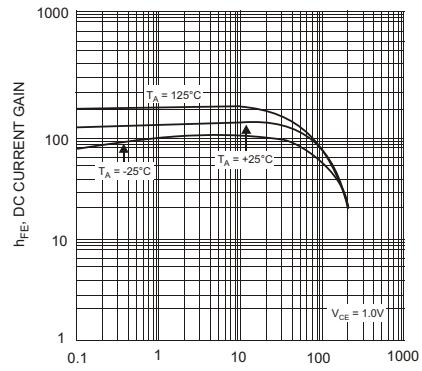


Fig. 7, Typical DC Current Gain vs
Collector Current (PNP-CH3906)

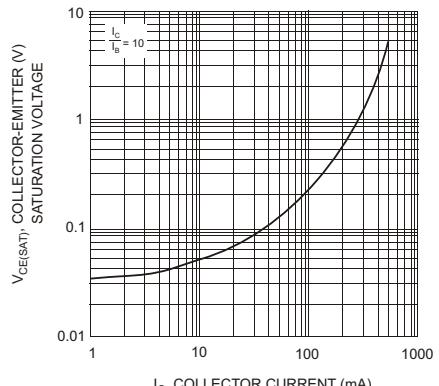


Fig. 8, Typical Collector-Emitter Saturation Voltage
vs. Collector Current (PNP-CH3906)

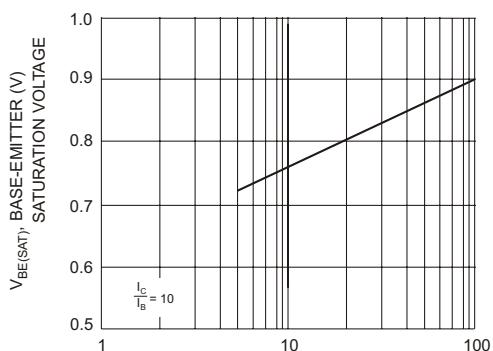


Fig. 9, Typical Base-Emitter
Saturation Voltage vs. Collector Current (PNP-CH3906)